## IEEE 1722 Call Meeting Minutes Aug 13, 2024 - 9:00 to 10:00am PDT

<u>Chair</u>: Dave Olsen (LG) – Present <u>Vice Chair</u>: Gordon Bechtel (Verizon) – Present <u>Secretary</u>: Don Pannell (NXP) – Present & took these minutes.

Attendees: 15 Adriaan Niess – Bosch Ashley Butterworth – Apple Daniel Hopf – Continental Dave Olsen – LG Electronics Douglas Chen – Marvell Don Pannell - NXP Geet Modi – Texas Instruments Gordon Bechtel - Verizon Hari Parmer – Marvell Hector Barreras - ADI Max Turner – Ethernovia Paul Fuller – Marvell Sanjeev Jain - Nvidia Thomas Thompson – IEEE Standards Association Thorsten Hoffleit – Renesas

Administrative items were covered, such as reminders about the IEEE patent & copyright policies: <u>https://standards.ieee.org/about/sasb/patcom/materials/</u> Patent policy was specifically reviewed. No patents claims were made.

Agenda:

Hari shared status / work on new Annex O draft. The goal is to have a new draft by end of this week so it can be informally discussed next week.

Sanjeev Jain presented Sensor to SoC Communication Protocol for 1722c: https://grouper.ieee.org/groups/1722/contributions/2024/IEEE\_1722\_Camera\_over\_ethernet\_proposal\_9Jul2024\_SanjeevJain.pptx

Next Meeting on 08/20/24: Annex O informal review – Birds of a Feather